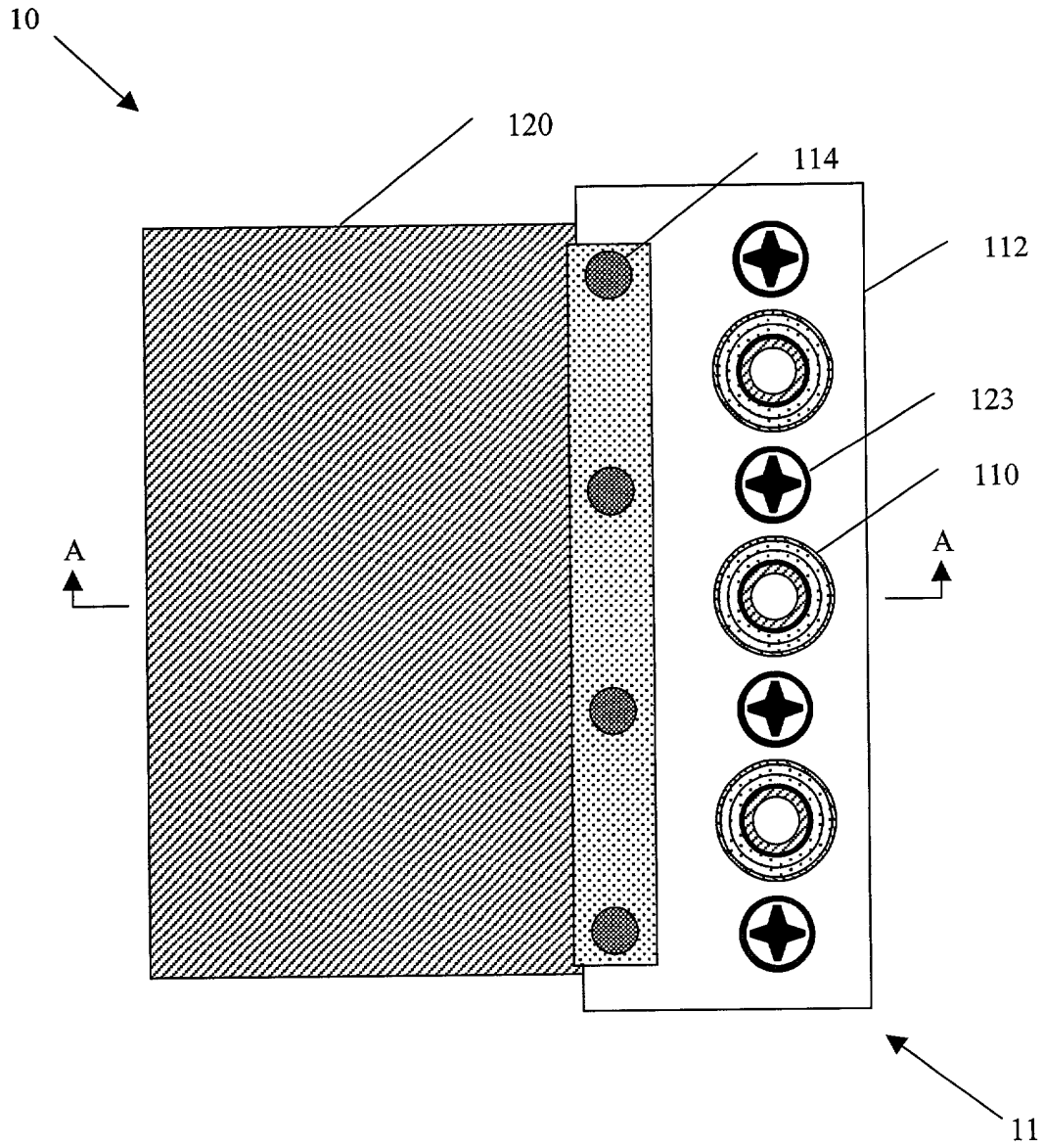
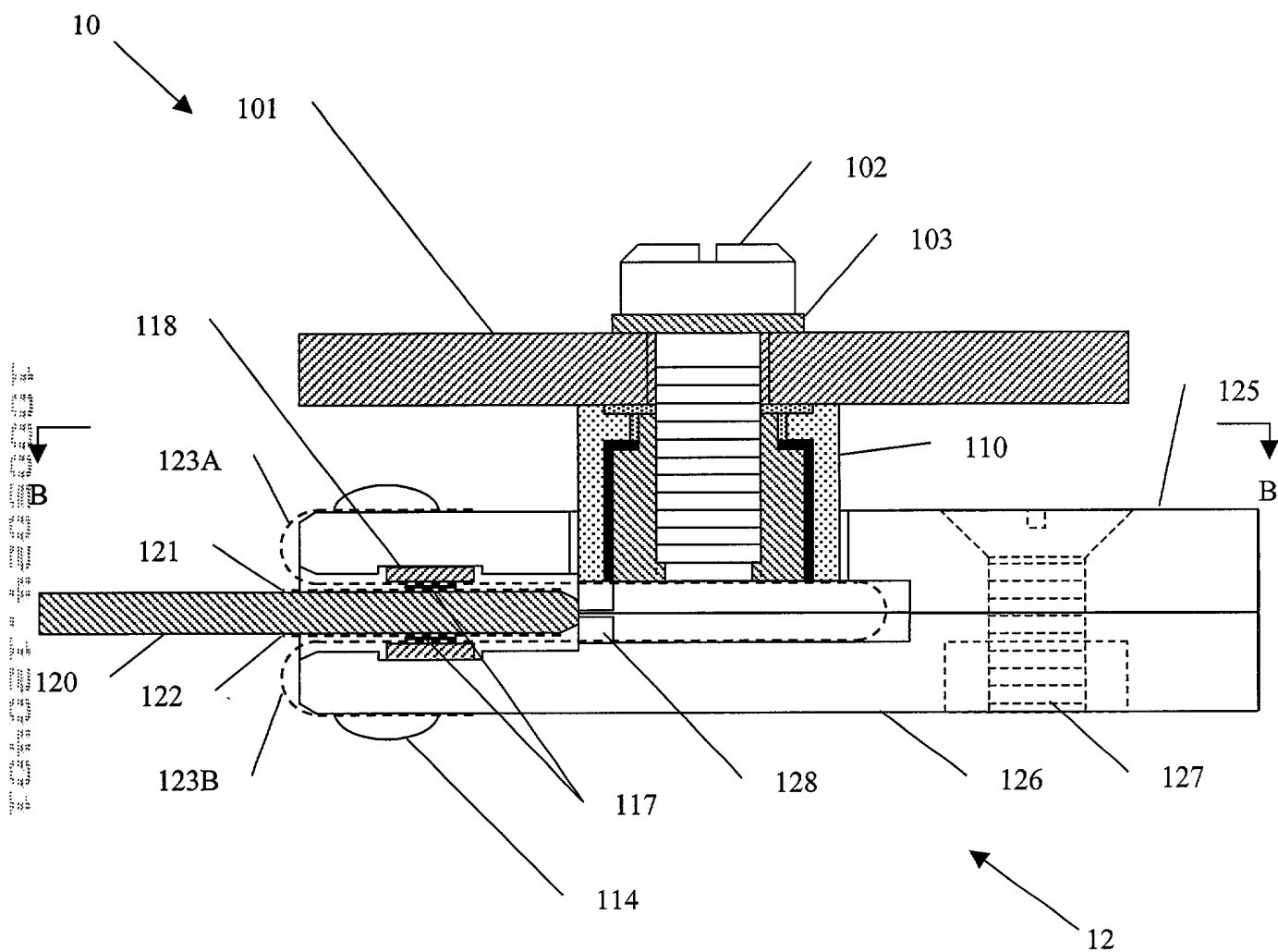


FIG. 1B is a cross-sectional view of the device 10 taken along line A-A of FIG. 1A. The device 10 includes a substrate 110, a first layer 112, a second layer 114, and a third layer 120. The first layer 112 is a conductive layer, the second layer 114 is a dielectric layer, and the third layer 120 is a conductive layer. The device 10 is a multi-layered structure with a central core 110 and outer layers 112 and 114. The third layer 120 is a conductive layer that is disposed on the first layer 112. The device 10 is a multi-layered structure with a central core 110 and outer layers 112 and 114. The third layer 120 is a conductive layer that is disposed on the first layer 112.

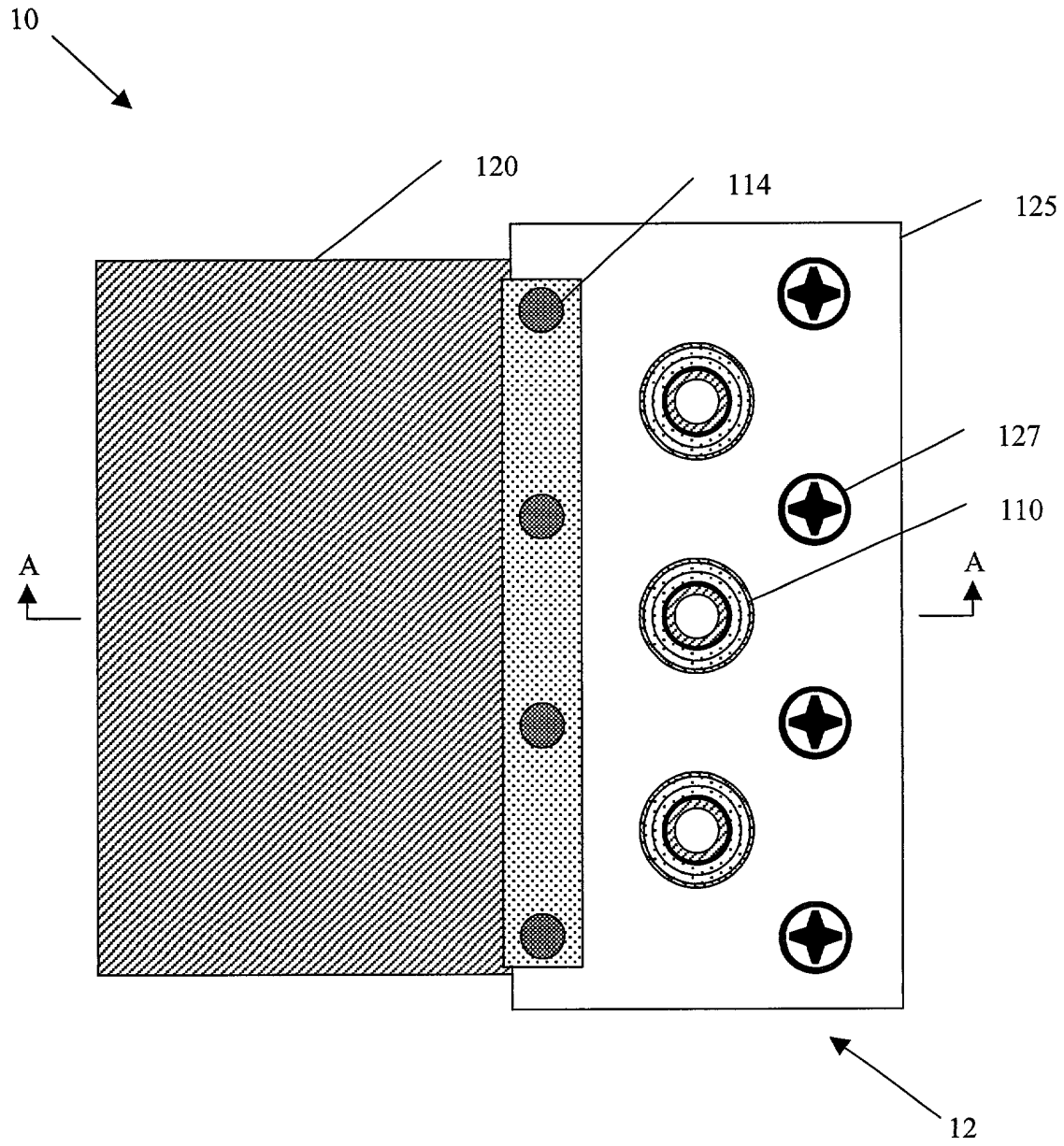


Section B-B
FIG. 1B

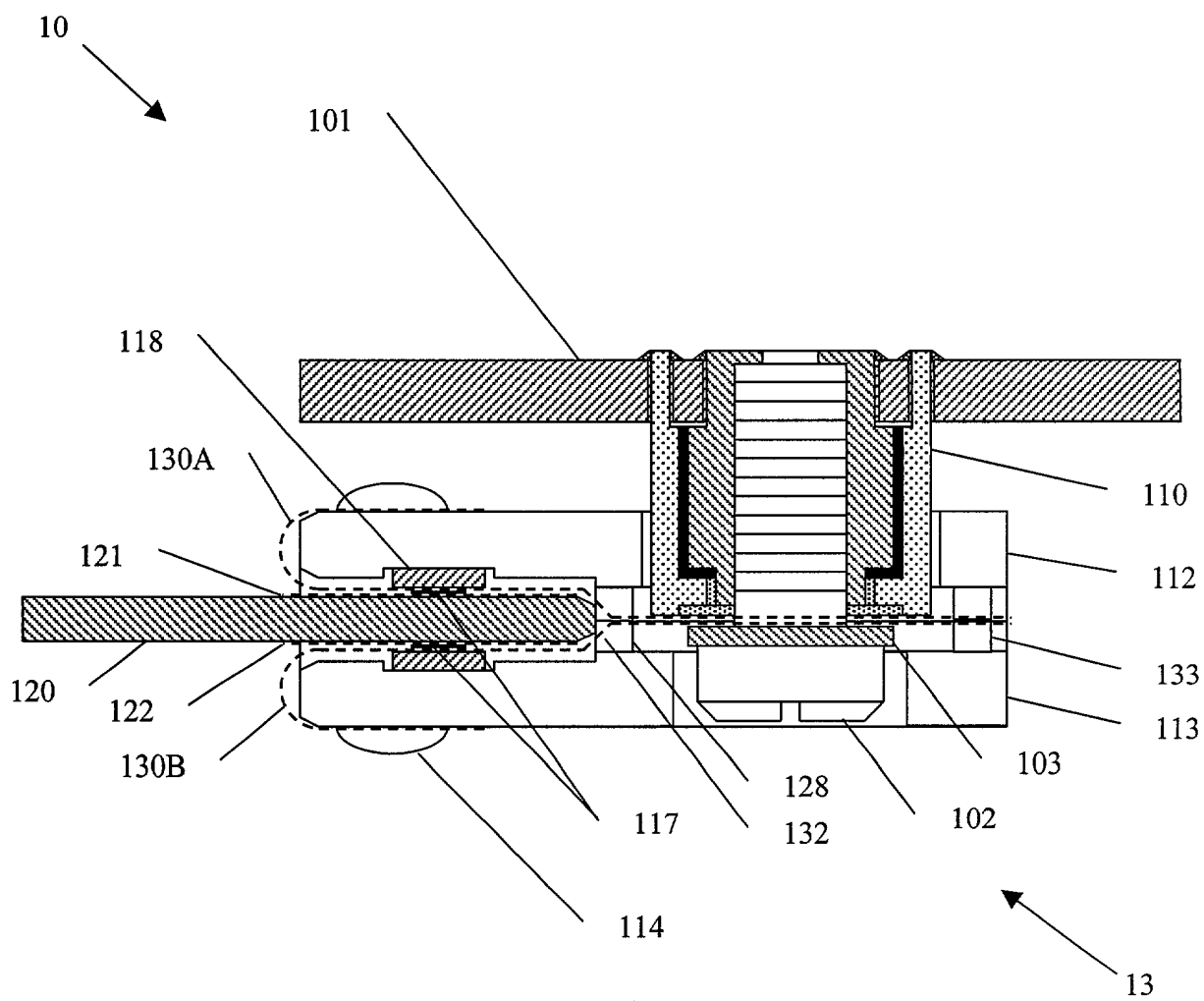


Section A-A
FIG. 2A

FIG. 2B is a cross-sectional view of the device 10 taken along line A-A of FIG. 2A. The device 10 includes a substrate 110, a first layer 114, a second layer 120, and a third layer 125. The first layer 114 is disposed on the substrate 110 and includes a plurality of openings 127. The second layer 120 is disposed on the first layer 114 and includes a plurality of openings 127. The third layer 125 is disposed on the second layer 120 and includes a plurality of openings 127. The openings 127 are aligned with each other in the first, second, and third layers 114, 120, and 125.



Section B-B
FIG. 2B



Section A-A
FIG. 3

10

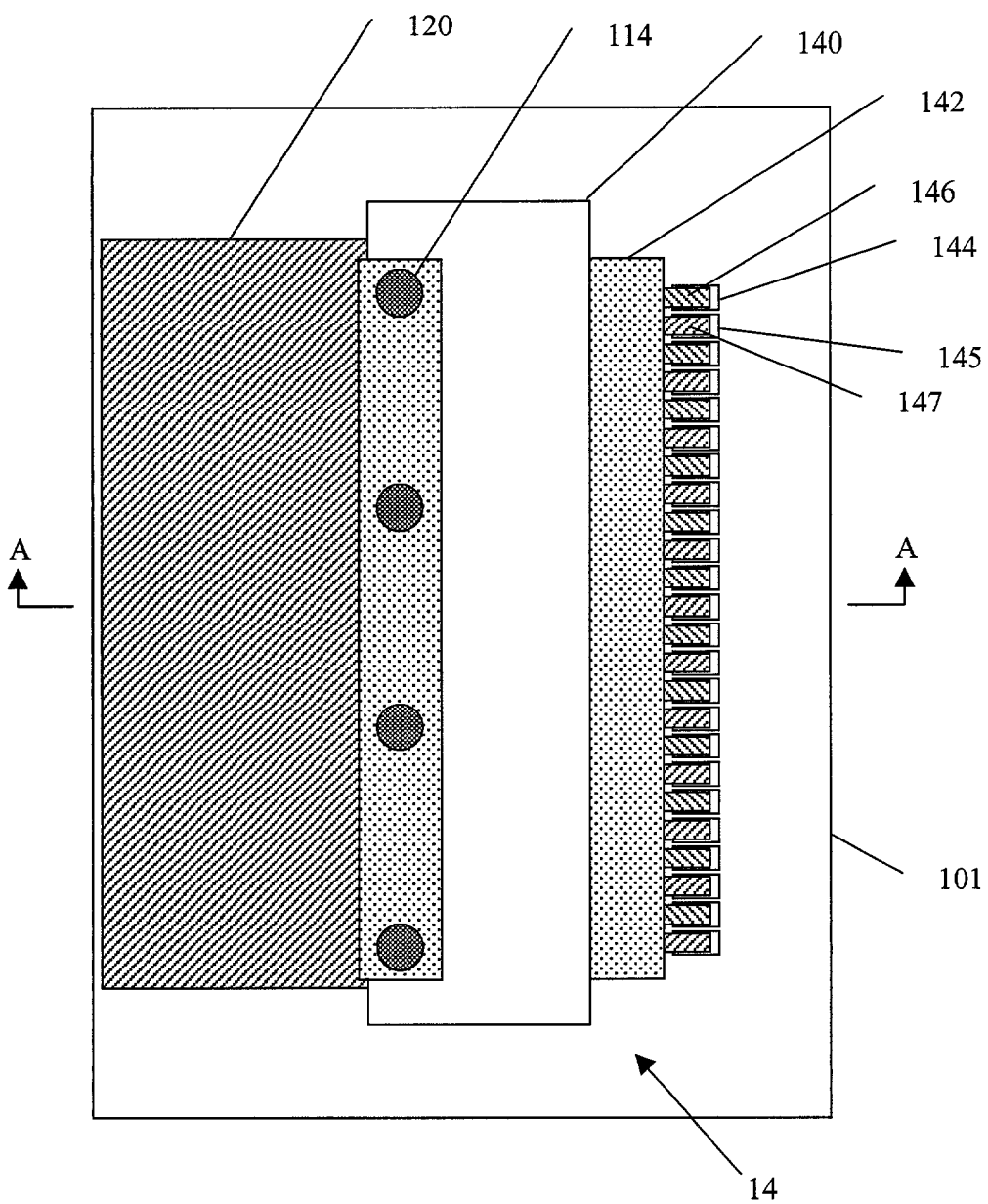


FIG. 4B

FIG. 5A is a schematic diagram of a device 500. The device 500 includes a substrate 502 and a plurality of components 504, 514, 508, 510, 115, 117. The components 504 are arranged in a vertical column on the left side of the substrate 502. The components 514 are arranged in a vertical column on the right side of the substrate 502. The components 508 and 510 are arranged in a vertical column on the right side of the substrate 502. The components 115 and 117 are arranged in a vertical column on the right side of the substrate 502.

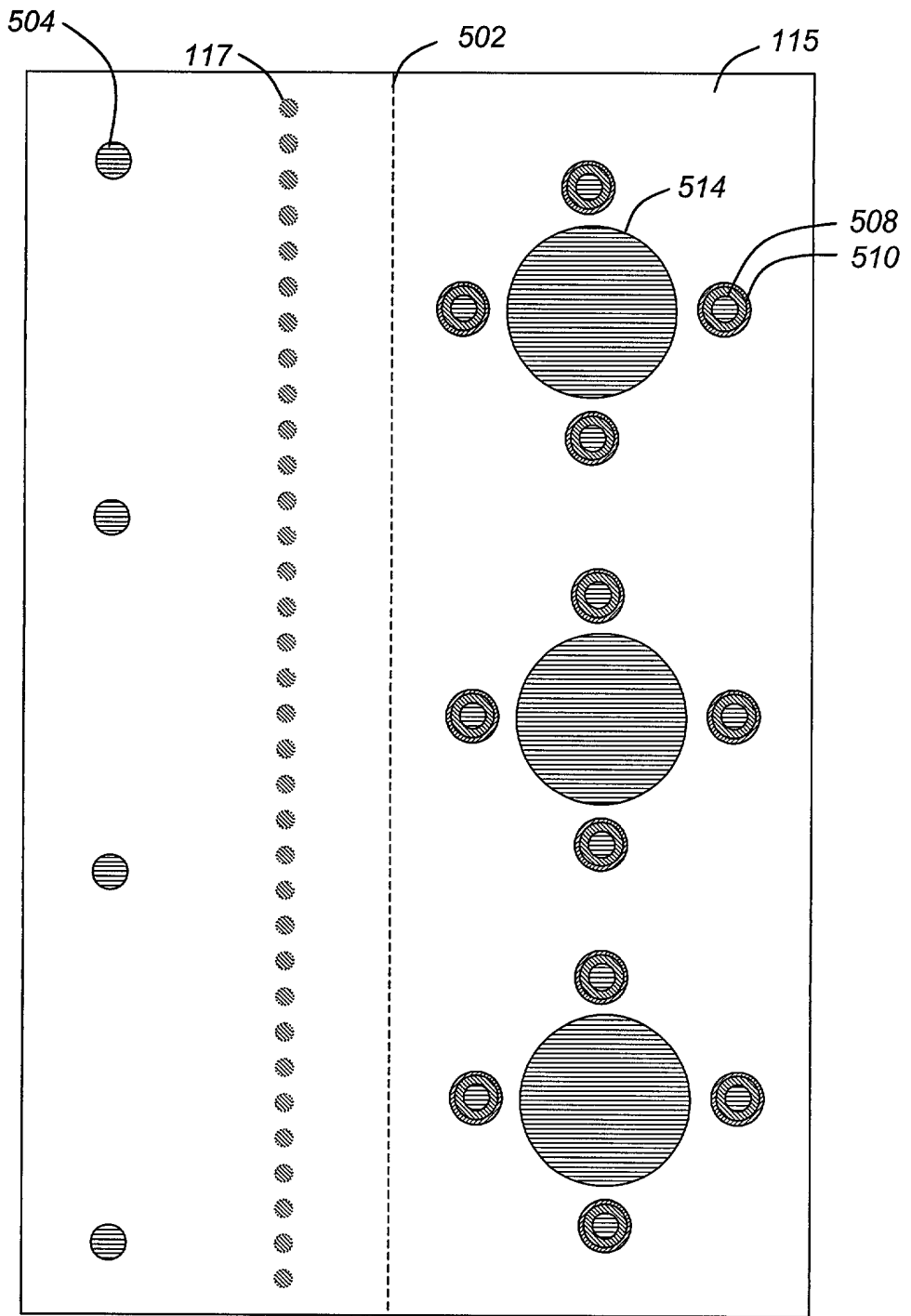


FIG. 5A

FIG. 5B is a schematic diagram of a device 100 in a second state. The device 100 is shown in a perspective view, and the dashed line 116 indicates a fold line. The device 100 is shown in a perspective view, and the dashed line 116 indicates a fold line. The device 100 is shown in a perspective view, and the dashed line 116 indicates a fold line.

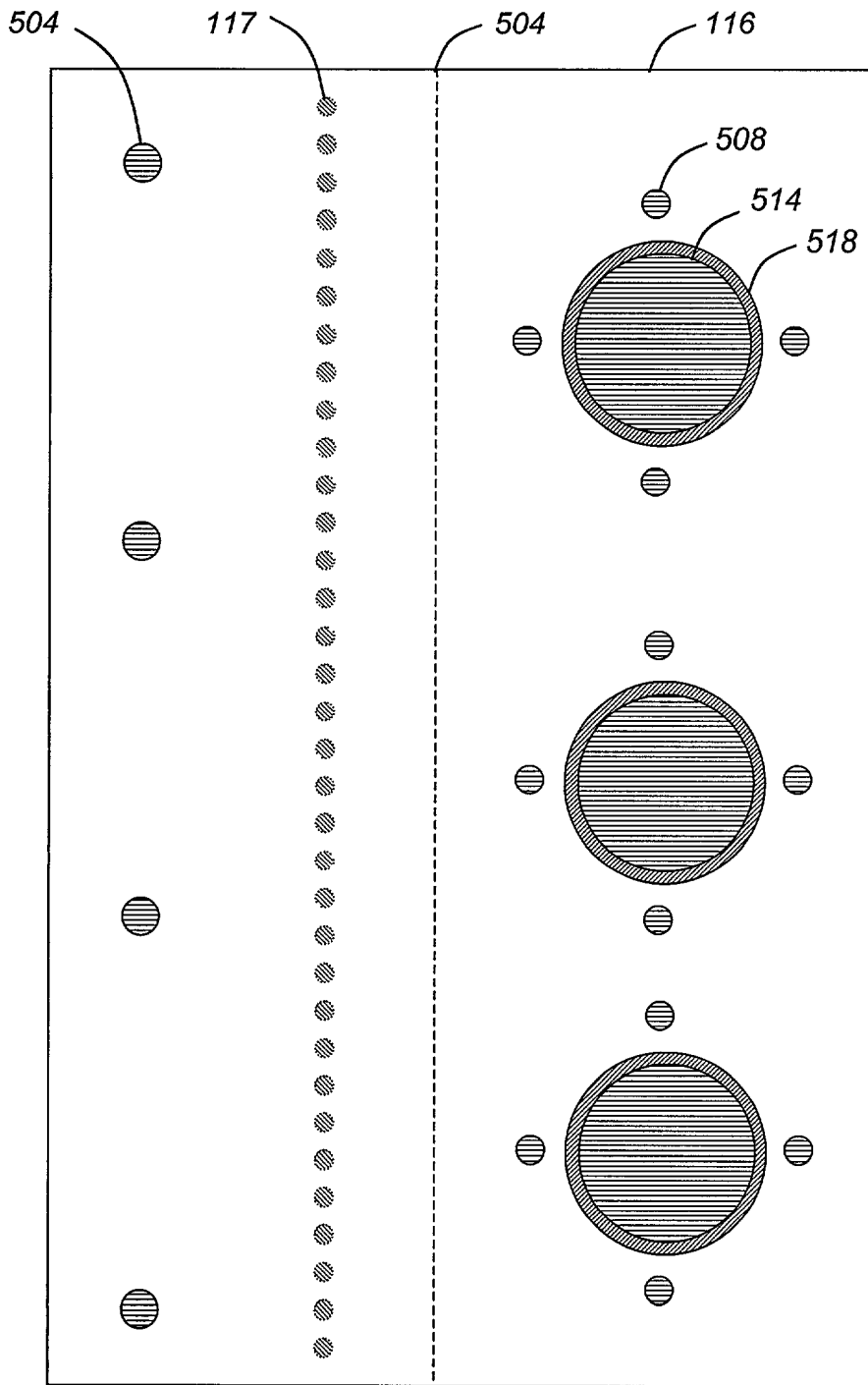


FIG. 5B